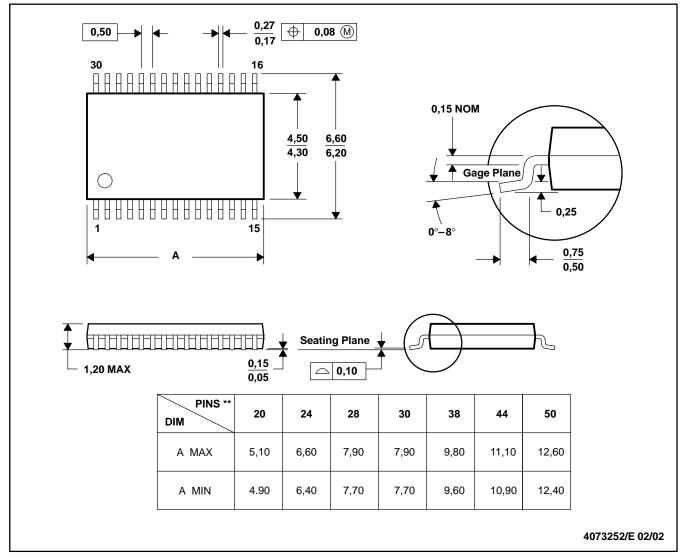
MECHANICAL DATA

MPDS019D - FEBRUARY 1996 - REVISED FEBRUARY 2002

DBT (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

30 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- $\label{eq:constraint} \textbf{C}. \quad \textbf{Body dimensions do not include mold flash or protrusion}.$
- D. Falls within JEDEC MO-153



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